

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT:

KarlHeinz Arndt, et al. DOCKET NO:

P01,040

SERIAL NO.:

10/009,656

ART UNIT:

41

2875

FILED:

March 26, 2002

EXAMINER:

Sharon E. I

CONF. NO.:

8441

TITLE:

LED Arrangement

Commissioner for Patents PO Box 1450 Alexandria, Virginia 22313-1450

INFORMATION DISCLOSURE STATEMENT PURSUANT TO 37 C.F.R. §1.97(c)

Sir:

In accordance with the provisions of 37 C.F.R. §1.56, Applicant respectfully requests that a citation and examination of the references identified on the attached PTO 1449 form be made during the course of examination of the above-identified application for United States Patent. This Information Disclosure Statement is being filed pursuant to 37 C.F.R. §1.97(c). Pursuant to 37 C.F.R. §1.17(p) enclosed is the fee for submission of an Information Disclosure Statement in the amount of \$180.00. Any deficiency or overpayment should be charged or credited to deposit account number 50-1519. A duplicate copy of this sheet is enclosed.

REMARKS

The following references listed on the PTO 1449 form are enclosed herewith are cited in the specification of the above-referenced application.

EXPLANATION OF RELEVANCE

Reference AA is an English language U.S. patent related to German patent document DE 29603557 previously submitted in this case.

Reference AL is an English language Great Britain patent document related to German patent document DE 4238417 previously submitted in this case.

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Reference AT is an English language abstract of European patent document EP 253244 previously submitted in this case.

Reference AU is an English language abstract of German patent document DE 19528459 previously submitted in this case.

Reference AV is an English language abstract of the article by Matthias Martin, Light Emitting Diodes previously submitted in this case.

Reference AW is an English translation of the article by Moellmer, et. al. Siemens-SMT-TOP-LED-LEDs for Surface Mounting previously submitted in this case.

The above citation of prior art is not a representation that such art constitutes a complete or exhaustive listing of all pertinent prior art, nor that it necessarily includes the closest or most relevant art. The aforementioned citation comprises a voluntary citation of prior art of which applicant and his attorney are presently aware and is not intended to serve as a substitute for the Examiner's own search.

Respectfully submitted,

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CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class mail in an envelope addressed to: Commissioner for Patents, PO Box 1450, Alexandria, Virginia 22313-1450 on August 20, 2003.

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Sheet 1 of 1 Serial No. Docket No. 10/009,656 Form PTO-1449 P01,0404 FORMATION DISCLOSURE CITATION Applicant Karlheinz Arndt, et al. IN AN APPLICATION Group Art Unit Filing Date AUG 2 5 2003 & (use several sheets if necessary) 2875 March 26, 2002 U.S. PATENT DOCUMENTS Filing Date If Subclass Class Name appropriate Examiner's Date Document Number **Initials** 05/21/1996 Woolverton 5,519,596 AA AB AC AD ΑE AF AG AH ΑI ΑJ AK FOREIGN PATENT DOCUMENTS Translation Subclass Class Country Date Document Number No Yes 05/19/1993 Great Britan 2 261 549 ALAM AN AO AΡ AQ \overline{AR} AS OTHER PRIOR ART (Including Author, Title, Date, Pertinent Pages, Etc.) Abstract of EP 253244 AT Abstract of DE 19528459 Abstract of Matthias Martin, Light Emitting Diodes, WELTLICHTSCHAU 4/99, p. 278-AU AV Moellmer, Frank & Waitl, Guenter, Siemens-SMT-TOP-LED-LEDs for Surface Mounting; Siemens Components XXVI (1991) No. 4-5, pp. 147-149. AW Date Considered Examiner *EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next

communication to applicant.